CT3031, CT3032, CT3033

CT3041, CT3042, CT3043

250V/400V Zero Cross 6-Pin Phototriac Optocoupler

Features

- High isolation 5000 VRMS
- Peak Breakdown Voltage
 - 250V CT3031,3032,3033
 - 400V CT3041,3042,3043
- Temperature range 55 ℃ to 100 ℃
- Regulatory Approvals
 - UL UL1577 (E364000)
 - VDE EN60747-5-5(VDE0884-5)
 - CQC GB4943.1, GB8898
 - IEC60065, IEC60950

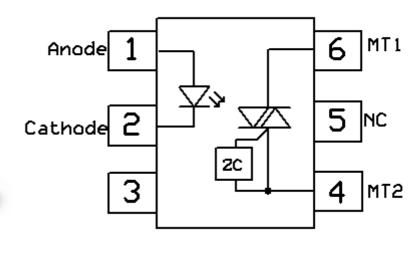
Applications

- Motor Controls
- Lamp ballasts
- Static AC Power Switch
- Solenoid/ Valve Control

Description

The CT3031, CT3032, CT3033, CT3041, CT3042 and CT3043 consists of a Zero Cross Photo Triac optically coupled to a gallium arsenide Infrared-emitting diode in a 6-Pin DIP package with different lead forming options.

Package Outline



Note: Different lead forming options available. See package

dimension.

Schematic



Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes	
Viso	Isolation voltage		5000	V _{RMS}	
Topr	Operating temperature		-55 ~ +100	°C	
Тѕтс	Storage temperature		-55 ~ +150	°C	
Tsol	Soldering temperature		260	°C	
Emitter					
lF	Forward current	60	mA		
I _{F(TRANS)}	Peak transient current (≤1µs P.W,300pps)	1	Α		
VR	Reverse voltage	6	V		
PD	Power dissipation	100	mW		
Detector					
PD	Power dissipation	300	mW		
		CT3031,3032,3033	250	V	
V _{DRM}	Off-State Output Terminal Voltage CT3041,3042,3043		400	V	
ITSM	Peak Repetitive Surge Current	1	А		



Electrical Characteristics *T_A* = 25 °C (unless otherwise specified)

Emitter Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward voltage	I _F =10mA	-	-	1.5	V	
IR	Reverse Current	$V_{R} = 6V$	-	-	5	μA	
CIN	Input Capacitance	f= 1MHz	-	45	-	pF	

Detector Characteristics

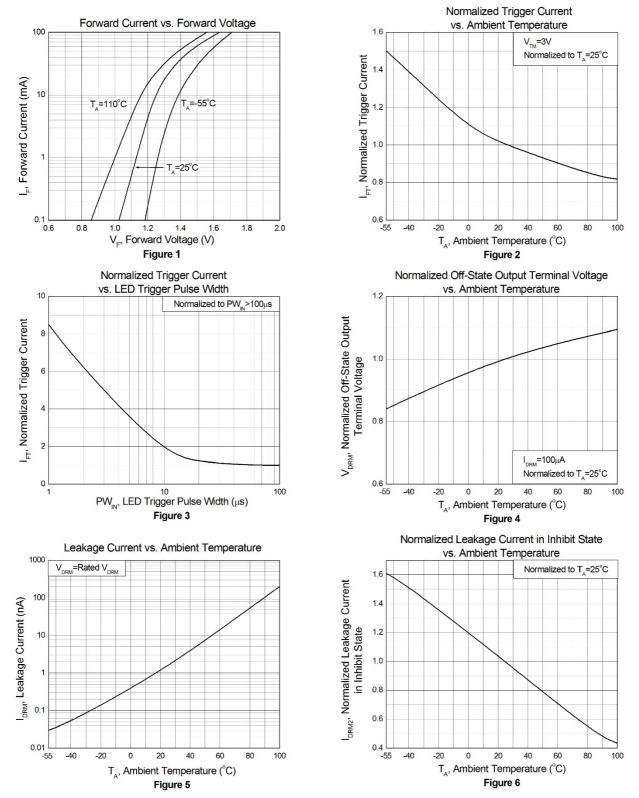
Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
I _{DRM1}	Peak Blocking Current	IF= 0mA, VDRM= Rated VDRM	-	-	100	nA	
Idrm2	Inhibit Leakage Current	IF= Rated IFT, VDRM= Rated VDRM	-	-	500	μA	
VINH	Inhibit Voltage	IF= Rated IFT,	-	-	20	V	
V _{TM}	Peak On-State Voltage	I _F = Rated I _{FT} , I _{TM} = 100mA	-	-	3	V	
dv/dt	Critical Rate of Rise off-State Voltage	VPEAK= Rated VDRM	1000	-	-	V/µs	

Transfer Characteristics

Symbol	P	arameters	Test Conditions	Min	Тур	Max	Units	Notes
	Input	CT3031, CT3041		-	-	15		
IFT	Trigger	CT3032, CT3042	Terminal Voltage = 3V	-	-	10	mA	
	Current	CT3033, CT3043		-	-	5		
Ін	Holding Cur	rent		-	270	-	μA	
RIO	Isolation Re	sistance	V _{IO} = 500V _{DC}	1x10 ¹¹	-	-		
Сю	Isolation Ca	pacitance	f= 1MHz	-	0.25	-	pF	



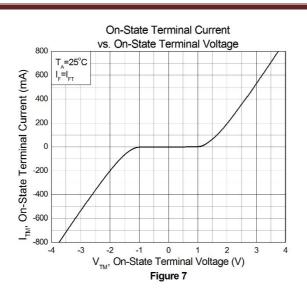
Typical Characteristic Curve

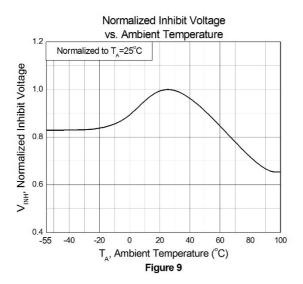


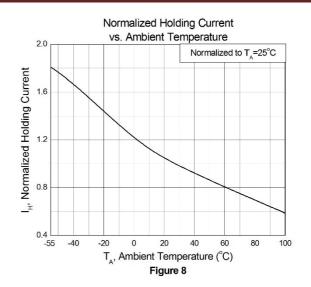


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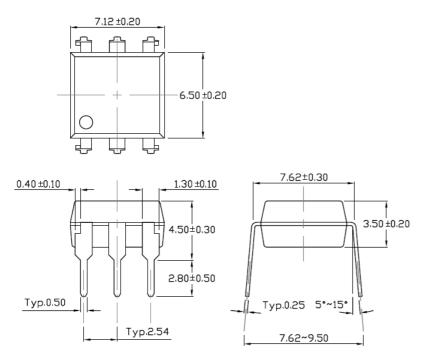




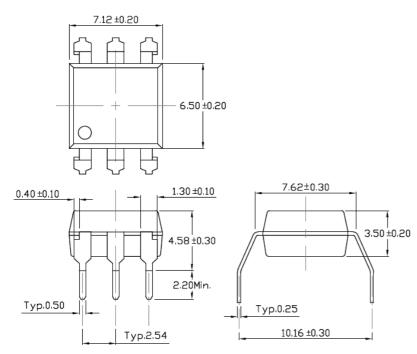


Package Dimension Dimensions in mm unless otherwise stated

Standard DIP – Through Hole

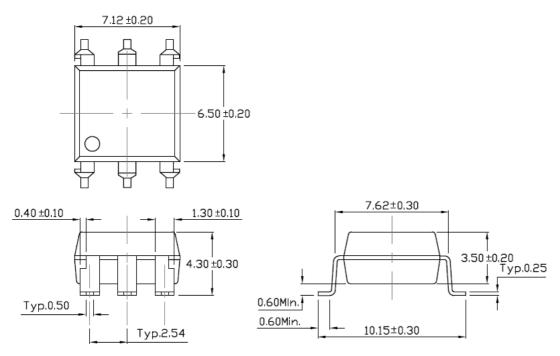


Wide Lead Forming – Through Hole (M Type)

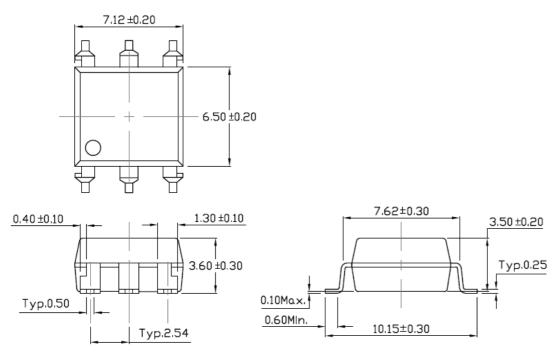




Surface Mount Forming (S Type)

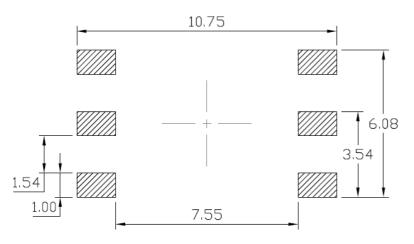


Surface Mount Forming (Low Profile) (SL Type)

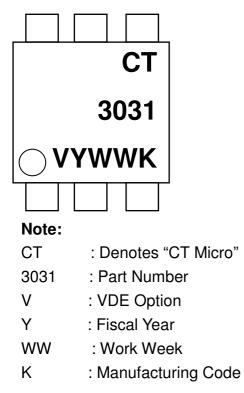




Recommended Solder Mask Dimensions in mm unless otherwise stated



Marking Information





Ordering Information

CT303X(Y)(Z)-G, CT304X(Y)(Z)-G

X = Part No. (X=1,2,3)

Y = Lead form option (S, SL, M or none)

Z = Tape and reel option (T1, T2 or none)

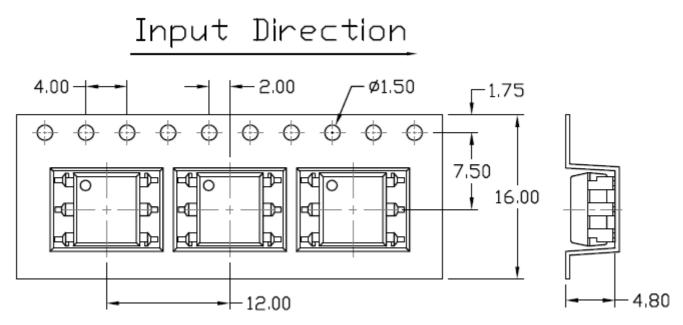
G= Material option (G: Green, None: Non-green)

Option	Description	Quantity
None	Standard 6 Pin Dip	50Units/Tube
М	Gullwing (400mil) Lead Forming	50Units/Tube
S(T1)	Surface Mount Lead Forming – With Option 1 Taping	1000 Units/Reel
S(T2)	Surface Mount Lead Forming – With Option 2 Taping	1000 Units/Reel
SL(T1)	Surface Mount (Low Profile) Lead Forming- With Option 1 Taping	1000 Units/Reel
SL(T2)	Surface Mount (Low Profile) Lead Forming – With Option 2 Taping	1000 Units/Reel

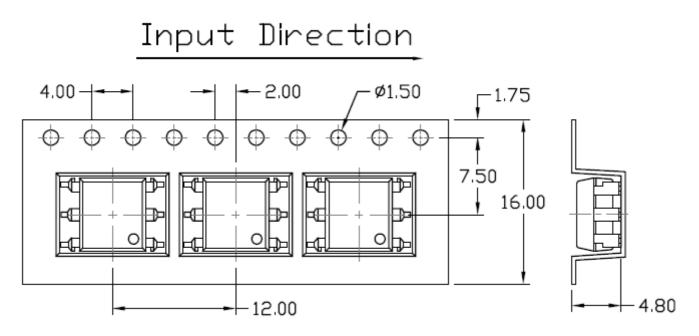


Carrier Tape Specifications Dimensions in mm unless otherwise stated

Option S(T1) & SL(T1)



Option S(T2) & SL(T2)

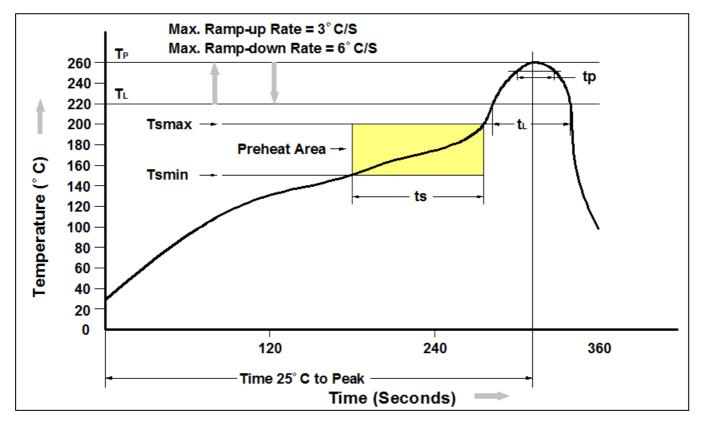




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Reflow Profile



Profile Feature	Pb-Free Assembly Profile		
Temperature Min. (Tsmin)	150 <i>°</i> C		
Temperature Max. (Tsmax)	200 <i>°</i> C		
Time (ts) from (Tsmin to Tsmax)	60-120 seconds		
Ramp-up Rate (t_L to t_P)	3℃/second max.		
Liquidous Temperature (TL)	217 <i>°</i> C		
Time (t _L) Maintained Above (T _L)	60 – 150 seconds		
Peak Body Package Temperature	260 ℃ +0 ℃ / -5 ℃		
Time (t _P) within 5 ℃ of 260 ℃	30 seconds		
Ramp-down Rate $(T_P \text{ to } T_L)$	6°C/second max		
Time 25℃ to Peak Temperature	8 minutes max.		



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